



PATENT APPLICATION

Docket No. 9903-067

Client No. S02US034

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Hyun-Ho KIM, et al.

Serial No. 10/620,745 Examiner: Tran, Thien F

Filed: July 15, 2003 Group Art Unit: 2811

Confirmation No. 8977

For: IN-LINE DIE ATTACHING AND CURING APPARATUS FOR A  
MULTI-CHIP PACKAGE

**TRANSMITTAL LETTER**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Enclosed for filing in the above-referenced application are the following:

- ☒ Response to Restriction Requirement
- ☒ Limited Recognition Under 37 CFR § 10.9(b)
- ☒ Return Post Card
- ☒ Any deficiency or overpayment should be charged or credited to deposit account number 13-1703. A duplicate copy of this sheet is enclosed.

Customer No. 20575

Respectfully submitted,

MARGER JOHNSON & McCOLLOM, P.C.

Hosoon Lee  
Limited Recognition Under 37 CFR § 10.9(b)

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Date: September 15, 2004

  
Li Mei Vermilya